

MAINTENANCE MANUAL RF BOARD 19D902123G1 FOR TMX-8712

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DESCRIPTION

The 800 MHz RF Board 19D902123G1 consists of the following circuits:

- A frequency synthesizer for generating the transmit carrier frequency and the receive circuit first mixer injection frequency.
- The transmit exciter and power control stages.
- The receive circuit front end, IF, and FM detector.
- Voltage regulators.

The RF Board is mounted in the bottom of the frame assembly. Refer to the Combination Manual for a mechanical layout of the radio. Figure 1 provides a block diagram of the synthesizer and Figure 2 of the receive and transmit circuits.

The transmitter and receiver adjustments are accessible from the top of the board. Chip components on the bottom of the board provide optimum RF performance, while being accessible for easy servicing by removing the friction fit bottom shields.

Selected use of sealed modules permits small board size as well as RF and mechanical protection for sensitive circuitry. Modules are not repairable and must be replaced if they are determined to be damaged.

CIRCUIT ANALYSIS

SYNTHESIZER CIRCUIT

The synthesizer generates all transmit and receive RF frequencies. The circuit uses a phase-locked VCO operating on the actual transmitter frequency of 806 to 825 MHz. In the direct (talk around) mode, the VCO is band shifted to operate at 851 to 870 MHz. The synthesizer's output signal is generated directly by the VCO module U201 and buffered

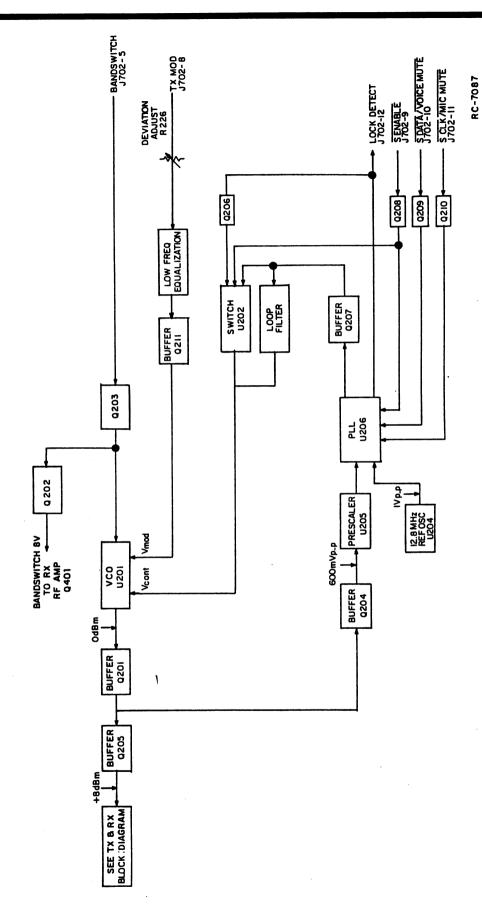


Figure 1 - Synthesizer Block Diagram

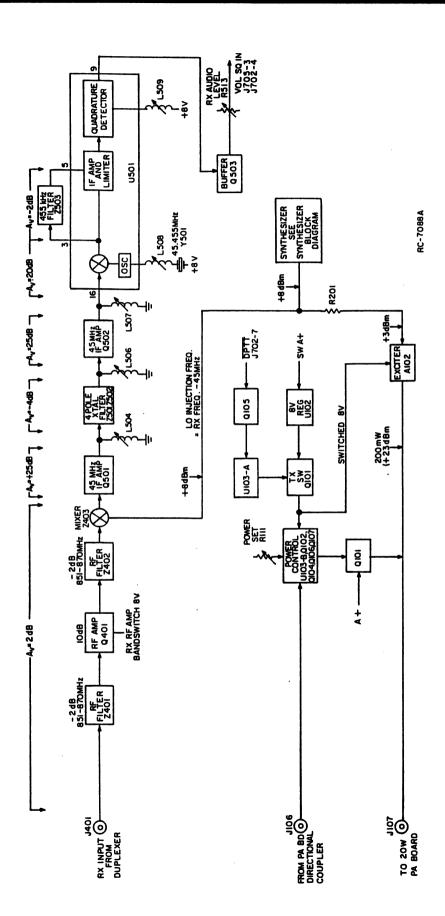


Figure 2 - Duplex Receive and Transmit Block Diagram

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by Q201 and Q205 to a level of +8 dBm (6 mW). This signal feeds the receiver mixer directly and is attenuated to +3 dBm by R201 to feed the transmitter exciter module.

The synthesizer frequency is controlled by the microprocessor on the Logic Board (A1). Frequency stability is maintained by a temperature compensated crystal controlled oscillator (TCXO) module U204 operating at 12.8 MHz. The oscillator has a stability of ± 2.5 PPM (0.00025%) over the temperature range of -30°C to +85°C and determines the overall frequency stability of the radio.

The buffered VCO output from Q201 is further buffered by Q204 to feed the divide by 128/129 dual modulus prescaler U205. The prescaler feeds the FIN input of the PLL U206. Within U206, the prescaled signal is further divided down to 12.5 kHz to be compared with a reference signal. This reference signal is derived from the 12.8 MHz TCXO module U204. U206 divides the 12.8 MHz signal down to the 12.5 kHz reference frequency.

Divider circuits in U206 are programmed by three inputs from the Logic Board (A1), which are buffered and inverted by transistors Q208, Q209, and Q210. The S ENABLE pulse activates switch U202 to allow more rapid channel acquisition during channel changes.

A LOCK DET signal from the PLL goes to the microprocessor for processing to prevent transmission when the VCO is not on frequency and to provide an error message to the user.

When the radio is used in the direct (talk around) mode, the VCO is bandswitched to transmit in the 851 to 870 MHz range. The BANDSWITCH line from the microprocessor is normally at a logic high and switches low during transmit in direct mode. Transistor Q203 buffers and inverts this signal to feed the VCO and Q202. Transistor Q202 provides the 8 volt supply voltage to the receiver RF preamp which is switched off when the BANDSWITCH line becomes active (logic low) during transmit in direct mode.

Audio modulation from the Audio Board (A3) is applied to the VCO module through DEVIATION ADJUST potentiometer R226 and buffer transistor Q211.

TRANSMITTER CIRCUIT

The transmitter consists of a fixed tuned 200mW exciter

module, a power control circuit, and a transmit voltage switch. A 20W Power Amplifier Board is housed in the Power Amplifier/Duplexer Assembly which is described in the maintenance manual for the assembly.

Exciter Module

The synthesizer drives the receiver mixer at +8 dBm and is attenuated to +3 dBm for driving the exciter input. The exciter module A102 operates from a switched 8 volt supply. The exciter module bandwidth is sufficiently wide that both the 806 to 825 MHz and 851 to 870 MHz bands are allowed. No tuning is required. Both input and output ports operate at 50 ohms impedance. The exciter module provides typically 20 dB of gain and 200 mW of output power to drive the 20W Power Amplifier in the Power Amplifier/Duplexer Assembly. The exciter output and the PA control voltage output appear at J107.

Power Control Circuit

The power control circuit samples the output power to maintain a constant power level across the band. Also, thermistors sense the heatsink temperature to throttle the power level down above +60°C. The circuit controls the supply voltage to the first amplifier stage of the PA module in the Power Amplifier/Duplexer Assembly. The control voltage is sent to the PA module via the exciter RF output jack J107.

The power control circuit receives a DC voltage from the directional coupler on the 20W PA Board via J106. This DC level, which is proportional to the output power, feeds the (-) input of amplifier U103-B. Power set pot R111 determines the DC level to the (+) input of U103-B. U103-B amplifies the difference between the (-) and (+) inputs, forcing the output power level to equal the power set level by varying the drive to Q102 and Q101. Q101 supplies the control voltage to the PA module U101. For example, if the output power level begins to drop below the power set level, the output of U103-B increases positively, causing Q102 to conduct less. The base of Q101 rises, increasing the control voltage to the PA module, which increases the output power level back to the desired set level.

Thermistors R118 and R129, buffered by Q106 and Q107, reduce the DC level to the (+) input of U103-B above 60°C. Q104, C123, and R105 improve the transient stability of the power control loop when the transmitter is keyed.

Transmit Switch

During transmit, the Logic Board (A1) microprocessor pulls the DPTT line low which is buffered by Q105 before feeding U103-A. The output of U103-A goes low to turn on Q103 which supplies SWITCHED 8V to exciter module A102 and the power control circuit.

RECEIVER CIRCUIT

The dual conversion receiver circuit consists of a front end section, a 45.0 MHz first IF, and a 455 kHz second IF with a FM detector. All audio processing and squelch functions are accomplished on the Audio Board (A3).

Front End Section

RF from the RX port on the duplexer is coupled to receiver input J401. RF selectivity is provided by two filters Z401 and Z402 on the input and output of RF amplifier transistor Q401. The filters are fixed tuned, 3 pole dielectric resonators with a bandwidth greater than 20 MHz to cover the 851 to 870 MHz band. About 2 dB of passband ripple is typical for this filter pair. Approximately 50 ohm impedance levels exist at the input and output ports of the filters.

RF Amplifier transistor Q401 is a low noise bipolar transistor biased with DC feedback. The feedback allows a stable operating point of about 10 milliamps, while allowing direct emitter grounding. Input matching is obtained with stripline L402. The amplifier load is primarily filter Z402. C404, C405, C410, and stripline L403 provide a low Q match to the filter. Transistor Q202 supplies 8 volts to the RF amp which is switched off when the BANDSWITCH line goes low while transmitting in direct mode.

Mixer Z403 is a doubly balanced diode mixer. This mixer is driven by a local oscillator signal from the synthesizer at +8 dBm to provide good intermodulation performance, spurious performance, and local oscillator isolation. The mixer conversion loss is typically 6 dB.

45 MHz IF

The first 45 MHJz IF amplifier transistor Q501 is a junction FET operated in the common gate mode. This configuration offers a typical input impedance of 75 ohms.

The output circuitry is tuned by L504 and loaded to provide the proper source termination for the four pole crystal filter which follows.

The output of the crystal filter is matched by second IF amplifier trransistor Q502. This port is also tuned by L506 and loaded to provide the proper filter termination. Transistor Q502 is a dual gate FET operating at a bias current of about 10 milliamps. The output of Q502 is tuned by L507 for maximum gain at 45 MHz and is loaded by the 2nd mixer in the U501 chip. This Q502 stage has a relatively high input and output impedance and has high isolation within the active device. The dual gate FET provides the isolation required.

Converter/IF/Detector IC

U501 is a MC3361 IC. Pins 1 and 2 connect to an internally biased oscillator transistor. The external circuitry of this oscillator transistor includes crystal Y501 and forms an oscillator circuit operating at 45.455 MHz. The frequency of this third mode oscillator is adjusted by inductor L508. The oscillator drives the internal balanced mixer. The 45 MHz IF signal is translated to 455 KHz and appears at Pin 3 of U501. This IF signal is filtered by 6 pole ceramic filter Z503 and drives the internal 455 KHz amplifier and limiter. The limited 455 KHz in turn drives an internal quadrature detector. The phase shift network needed by the quadrature detector is provided by inductor L509. The audio output port is Pin 9 on U501. Inductor L509 is adjusted for maximum audio output level. The audio signal at Pin 9 is filtered by resistor R512 and capacitor C519 to reduce IF feedthrough. Buffer amplifier Q503 drives audio potentiometer R513. This allows a VOL/SQ HI signal whose amplitude may be set for proper system operation using R513.

POWER DISTRIBUTION

Unswitched 13.8 Volts (A+) is supplied to the RF Board through connector J704 and feeds the power control transistor Q101 and 20V transient suppressor D105. D105 provides reverse polarity protection and protects the module from noise spikes and other overvoltage transients appearing on the input power cable.

Switched 13.6 Volts (SW A+) is supplied to the RF Board through J704 and J705 and feeds regulators U102, U207, and U502. U102 supplies 8 Volts to the transmitter switch, the synthesizer 5 Volt regulator U203, and the Logic

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Board (A1) through J702. U207 supplies 8.3 Volts to the synthesizer. U502 supplies 8 Volts to the receiver.

SERVICE NOTES

TRANSMITTER CIRCUIT

Most transmitter circuit problems can be isolated by checking the TX power gains shown in Figure 1 - RX and TX Block Diagram.

Transmitter DC Measurements

1. First ensure that the DPTT is low when the mic PTT is keyed low.

- 2. Check for approximately 8 Volts at L105 feeding the Exciter Module. If not present, troubleshoot the TX switch circuitry, Q103 and U103.
- Check for an adjustable voltage of 0 to 12 volts on Q101 emitter. At maximum power, with Power Set adjustment R111 fully clockwise, the voltage should be 12 volts. If not present, check the power control circuitry: U103, Q101, Q102, Q104, Q106, and Q107.

SYNTHESIZER CIRCUIT

Synthesizer troubleshooting consists of first checking for the proper DC levels, then determining if the proper waveforms are present and checking individual modules.

RECEIVER CIRCUIT

To isolate a receiver circuit problem refer to the Receiver circuit Symptoms and Checks chart below.

RECEIVER CIRCUIT SYMPTOMS AND CHECKS

SYMPTOMS	CHECKS	
No Audio	1. U502 regulator	
	 The level and frequency of the first mixer injection frequency. 	
	 The level and frequency of the second mixer injection frequency. 	
	4. Quadrature detector circuit	
	5. Quadrature detector coil tuning	
Poor SINAD	Consult Figure 2 - RX and TX Block Diagram for RX stage gains and troubleshoot.	
	2. Input cable	
Distorted Audio	1. Both mixer injection frequencies	
	2. Quadrature detector coil tuning	
	3. Crystal filter source and load tuning	
	4. Z503: 455 KHz ceramic filter	

DC Analysis

8.3 Vdc is supplied by regulator U207 and serves as the biasing voltage for transistor circuits Q201, Q204, Q205, Q206, Q207, Q208 and Q210. Resistor R211 decouples the 8.3 volts for use in VCO module U201. The 10 milliamp current drain of this module results in approximately 8.1 volts DC on Pin 4.

Regulator U203 uses the 8 volts from transmitter regulator U102 to generate 5 volts for U204 and U205.

Waveforms

Synthesizer waveforms in Figures 3 through 8 were measured with a 10 megohm, 30 pF probe. Use DC coupling.

Module Isolation

Reference Oscillator U204:

Look for a waveform similar to the reference (Figure 3) on Pin 2. If waveform is not present, the oscillator module is probably defective.

VCO U201:

Connect a DC power supply to pin 3. With 2.5 Vdc on pin 3, the output of U201 (pin 5) should be approximately 803 MHz. With 6.5 Vdc on pin 3, the output should be approximately 828 MHz. Either transmit in direct mode or force the BANDSWITCH line to ground which will cause pin 1 to go to 8 volts. The frequencies for 2.5 Vdc and 6.5 Vdc should be approximately 45 MHz higher.

Power output of the VCO can be measured by connecting a coax directly to the module, between pin 5 and ground.

The output should be approximately 0 dBm with C211 still connected in the circuit.

Prescaler U205:

Connect pin 3 of the VCO to 4.5 volts DC. With the radio in receive, monitor the frequencies of the VCO at the connection of capacitor C201 and resistor R201. DC short pin 7 of U205 to ground to cause divide by 129 to occur. The frequency output at pin 5 should be the VCO frequency divided by 129. Tie pin 7 to pin 1 (5 volts) to cause divide by 128 to occur. Check pin 5 to verify that this occurs. Improper division may indicate a defective prescaler.

Bilateral Switch U202:

The bilateral switch is used to short around parts of the loop filter during channel scan. A shorted (to ground or adjacent gate) gate may be isolated by comparing voltages through the loop filter to those of a functioning radio. Defective gates might be suspected when the radio does not change frequency quickly enough.

Phase-Lock-Loop U206:

There are no other specific checks which aid in evaluation of U206. Usually, it is suspected only if all other checks are OK. Before changing, inspect chip components for mechanical damage and check resistances through the loop filter.

Transistors Q201 and Q205:

After checking for proper DC operation, measure the gain from VCO pin 5 to R201/C201. The gain should be approximately 8 dB.



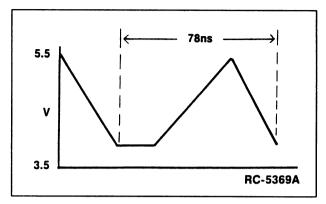


FIGURE 3 - REFERENCE OSCILLATOR (INPUT TO U206, PIN 2).

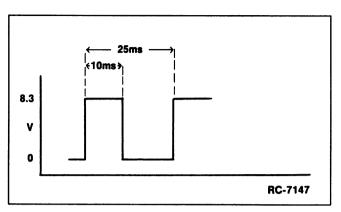


FIGURE 6 - S ENABLE (INPUT TO U206, PIN 13). USING TEST MODE FUNCTION S10.

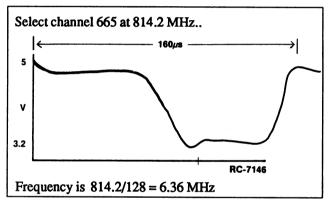


FIGURE 4 - FIN (INPUT TO U206, PIN 10).

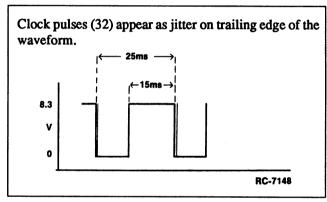


FIGURE 7 - S CLOCK (INPUT TO U206, PIN 11). USING TEST MODE FUNCTION S10.

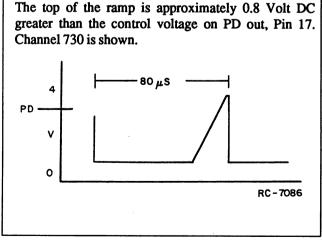


FIGURE 5 - RAMP (GENERATED IN U206 AND APPEARS ON PIN 15).

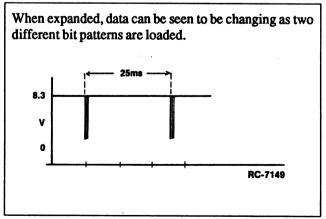


FIGURE 8 - S DATA (INPUT TO U206, PIN 12). USING TEST MODE FUNCTION S10.

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YMBOL	GE PART NO.	DESCRIPTION
A102		EXCITER BOARD
		19C851708G1
C1 and C2	19A702061P45	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.
СЗ	19A702061P8	Ceramic: 3.9 pF <u>+</u> 0.5 pF, 50 VDCW, temp coef 0 <u>+</u> 120 PPM/'C.
C4	19A702061P77	Ceramic: 470 pF +5%, 50 VDCW, temp coef 0 +30 PPM/'C.
C5	19A702061P45	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.
C6	19A702061P7	Ceramic: 3.3 pF ±0.5 pF, 50 VDCW, temp coef 0 ±120 PPM/'C.
C7 and C8	19A702061P45	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.
C9	19A702052Pl4	Ceramic: 0.01 uF +10%, 50 VDCW.
C10	19A702061P45	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.
Ll and		Part of PWB 19C851707P1.
L2 L3	19B800891P2	Coil, RF Choke: sim to Paul Smith SK-890-1.
Ql	19A704708P2	Silicon, NPN: sim to NEC 2SC3356.
Q2	19A705436P1	Silicon, NPN: sim to Motorola MRF0211L.
Q3	19A701940P3	Silicon, NPN: sim to SRF-5116.
		RESISTORS
Rl	19B801251P471	Composition: 470 ohms <u>+</u> 5%, 150 VDCW, 1/8 w.
R2	19B801251P272	Metal film: 2.7K ohm ±5%, 150 VDCW.
R 3	19B801251P330	Metal film: 33 ohm <u>+</u> 5%, 150 VDCW.
R4	19B801251P331	Metal film: 330 ohm ±5%, 150 VDCW.
R5	19B801251P392	Metal film: 3.9K ohm <u>+</u> 5%, 150 VDCW.
R6	19B800607P330	Metal film: 33 ohms ±5%, 200 VDCW, 1/8 w.
R7	19B801251P471	Composition: 470 ohms ±5%, 150 VDCW, 1/8 w.
R8	19B801251P332	Metal film: 3.3K ohm ±5%, 150 VDCW.
R9 and R10	19B800607P470	Metal film: 47 ohms ±5%, 200 VDCW, 1/8 w.
C105	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C107	19A701534P8	Tantalum: 22 uF ±20%, 16 VDCW.
C110	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C111	19A703314P10	Electrolytic: 10 uF -10+50% tol, 50 VDCW; sim to Panasonic LS Series.
C114	19A702061P33	Ceramic: 27 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/`C.
C117	19A702052P22	Ceramic: 0.047 uF ±10%, 50 VDCW.
C118	19A703314P10	Electrolytic: 10 uP -10+50% tol, 50 VDCW; sim to Panasonic LS Series.
C119	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.
	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
C121	134/02032120	Ceramic. O.1 ur -10%, 30 VDCW.

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

	SYMBOL	GE PART NO.	DESCRIPTION	Ī
	C123	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.	ſ
	C125	19A702061P33	.Ceramic: 27 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/ $^{\circ}$ C.	
	C133 thru C139	19A702061P33	Ceramic: 27 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPH/ $^{\circ}$ C.	
7	C141	19A702052P26	Ceramic: 0.1 uF <u>+</u> 10%, 50 VDCW.	
1	C142	19A701534P10	Tantalum: 10 uF <u>+</u> 20%, 25 VDCW.	
┨	C143	19A702052P26	Ceramic: 0.1 uF <u>+</u> 10%, 50 VDCW.	
	C201 thru C203	19A702061P61	Ceramic: 100 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/'C.	
1	C204	19A702052P26	Ceramic: 0.1 uF \pm 10%, 50 VDCW.	
1	C205	19A701534P17	Tantalum: 47 uF <u>+</u> 20%, 10 VDCW.	ıl
	C206	19A702061P9	Ceramic: 4.7 pF \pm 0.5 pF, 50 VDCW, temp coef 0 \pm 60 PPM/ C.	П
	C207 and C208	19A701534P17	Tantalum: 47 uF <u>+</u> 20%, 10 VDCW.	
1	C209	19A702061P5	Ceramic: 2.2 pF \pm 0.5 pF, 50 VDCW, temp coef 0 \pm 120 PPM/'C.	
ı	C210	19A702052P14	Ceramic: 0.01 uF \pm 10%, 50 VDCW.	
l	C211	19A702061P9	Ceramic: 4.7 pF \pm 0.5 pF, 50 VDCW, temp coef 0 \pm 60 PPM/'C.	
	C212	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.	
ı	C213	19A702052P14	Ceramic: 0.01 uF <u>+</u> 10%, 50 VDCW.	Н
	C215	19A700004P1	Metallized polyester: 0.068 uF ±10%, 63 VDCW.	
	C216	19A702052P14	Ceramic: 0.01 uF <u>+</u> 10%, 50 VDCW.	Н
	C217	19A700004P11	Metallized Polyester: 1.0 uF <u>+</u> 10%, 63 VDCW.	
	C220	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.	
	C221	19A702052P26	Ceramic: 0.1 uF <u>+</u> 10%, 50 VDCW.	
l	C222	19A702061P99 19A702052P14	Ceramic: 1000 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/°C.	
1	C223	19A702052P14 19A702061P77	Ceramic: 0.01 uF \pm 10%, 50 VDCW. Ceramic: 470 pF \pm 5%, 50 VDCW, temp coef	
	0224	138/020011//	0 ±30 PPM/'C.	
	C225	19A702061P99	Ceramic: 1000 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PFM/ $^{\circ}$ C.	
	C226	19A701534P17	Tantalum: 47 uF ±20%, 10 VDCW.	Н
ı	C227	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.	Н
	C228	19A702061P9	Ceramic: 4.7 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM/'C.	
	C229	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW; temp coef 0 ±30 PPM/'C.	
1	C230 C231	19A702052P26 19A703314P2	Ceramic: 0.1 uF <u>+</u> 10%, 50 VDCW. Tantalum: 220 uF, -10+50%, 10 VDCW.	П
1	C231	198702052914	Ceramic: 0.01 uF ±10%, 50 VDCW.	П
	C232 *	19A702052F14	Ceramic: 4.7 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM/'C.	
	C402	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.	
	C403	19 A 702061P99	Ceramic: 1000 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/ $^{\circ}$ C.	
	C404	19A702236P1	Ceramic: 0.5 pF \pm .1 pF, 50 VDCW, temp coef 0 \pm 30 PPM/'C.	
	C405	19A702236P21	Ceramic: 6.8 pF <u>+</u> 0.5 pF, 50 VDCW, temp coef 0 <u>+</u> 60 PPM/ [†] C.	Ш
	C407	19A702061P25	Ceramic: 18 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/°C.	
	C409 and C410	19A702236P9	Ceramic: 1.8 pF ±0.25 pF, 50 VDCW, temp coef 0 ±30 PPM/'C.	
	C411	19A702236P10	Ceramic: 2.2 pF ±2.5 pF, 50 VDCW, temp coef 0 ±30 PPM/'C.	
	C502	19A702061P99	Ceramic: 1000 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/ $^{\circ}$ C.	
	C503	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.	
	C504 *	19A702061P12	Ceramic: 8.2 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM/'C.	
	C505 *	19A702061P41	Ceramic: 39 pF <u>+</u> 5%, 50 VDCW, temp coef 0 <u>+</u> 30 PPM/'C.	

SYMBOL	GE PART NO.	DESCRIPTION
C506	19A701534P7	Tantalum: 10 uF ±20%, 16 VDCW.
C507 thru C509	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C510	19A702061P6	Ceramic: 2.7 pF ±0.5 pF, 50 VDCW, temp coef 0 ±120 PPM/'C.
C511	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C512	19A702061P1	Ceramic: 1 pF ±0.5 pF, 50 VDCW.
C513	19A702061P12	Ceramic: 8.2 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM/'C.
C514	19A702061P33	Ceramic: 27 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.
C515 and C516	19A702061P29	Ceramic: 22 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/'C.
C517 and C518	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
C519	19A702052P5	Ceramic: 1000 pF ±10%, 50 VDCW.
C520	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C521	19A703314P10	Electrolytic: 10 uF -10+50% tol, 50 VDCW; sim to Panasonic LS Series.
C522	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
D105	19A703588P3	Zener, transient suppressor: sim to 1N6278A.
D106	19A134587P2	Silicon, fast recovery: 100 mW; sim to Amperex BAV 70 Series.
D107	T324ADP1041	Silicon: general purpose.
D201	19A702525P2	Silicon.
D501 and D502	19A700028P1	Silicon, fast recovery: fwd current 75 mA, 75 PIV; sim to Type 1N4148.
J106 and J107	19B801341P1	RF Jack.
J201	19A700072P28	Printed wire: 2 contacts rated @ 2.5 amps; sim to Molex 22-27-2021.
J401	19B801341P1	RF Jack.
J501	19A700072P1	Printed wire: 2 contacts rated @ 2.5 amps; sim to Molex 22-03-2021.
J702	19A704779P11	Connector; sim to Molex 22-17-2122.
J704	19A700072P29	Printed wire: 3 contacts rated at 2.5 amps; sim to Molex 22-27-2031.
J705	19A700072P30	Printed wire: 4 contacts rated at 2.5 amps; sim to Molex 22-27-2041.
L104 and L105	19A704921P1	Coil.
L107	19A700024P1	Coil, RF: 100 nH ±10%, 0.08 ohms max DC res, 100 v.
L401 thru L403		Part of PWB 19D902124P1.
L502 and L503	H343CLP10022	Coil, Fixed: 10 uH +10%.
L504	19B801413P4	Coil, 39 MHz.
L505	19B209420P21	Coil, RF: 4.7 uH ±5%, 1.20 ohms max DC res; sim to Jeffers 4436-8J.
L506 thru L508	198801413P4	Coil, 39 MHz.
L509	19B801415P2	Transformer: 455 KHz; sim to AEPD 162B3277P17.
0101	10001167-000	
Q101	19A116742P2	Silicon, NPN.
Q102	19A703197P2	Silicon, PNP: sim to MMBT4403 Low Profile Pkg.
Q103	19A704972P1	Silicon, PNP: sim to Motorola 2N4918.

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO
Q201	19A704708P2	Silicon, NPM: sim to NEC 28C3356.	R218	19B800607P102
Q202	19A700059P2	Silicon, PMP.	R219	19B800607P103
Q203	19A700076P2	Silicon, NPN.	R220	19B800607P27
Q204	19A704708P2	Silicon, NPN: sim to NEC 2SC3356.	R221	19B800607P104
and Q205			R222	19B800607P33
Q206	19A700076P2	Silicon, NPM.	R223	19B800607P56
Q207	19A700059P2	Silicon, PNP.	R224	19B800607P47
Q208	19A700023P2	Silicon, NPN: sim to 2N3904.	R225	19B800607P27
Q209	19A702084P2	Silicon, NPN: sim to MPS 2369.	R226	19B800779P4
and Q210			R227	19B801251P47
Q211	19A700076P2	Silicon, NPN.	R228	19B800607P22
Q401	19A704708P2	Silicon, NPN: sim to NEC 28C3356.	R229	19B800607P82
Q501	19A702524P2	N-Type, field effect: sim to MMBFU310.	R230	19B800607P33
Q502	19A116818P3	N Channel, field effect: sim to Type 3N1877.	R231	19B800607P47
Q503	19A700023P2	Silicon, NPN: sim to 2N3904.	R232	19B800607P10
			R233	19B800607P33
		RESISTORS	R234	19B800607P47
R103	19B800607P821	Metal film: 820 ohms ±5%, 200 VDCW, 1/8 w.	R235	19B800607P68
R104	19B800607P223	Metal film: 22K ohms ±5%, 200 VDCW, 1/8 w.	R236	19B800607P47
105	19B800607P473	Metal film: 47K ohms ±5%, 200 VDCW, 1/8 w.	R237	19B800607P10
R107	19B800607P393	Metal film: 39K ohms <u>+</u> 5%, 200 VDCW, 1/8 w.	thru R239	
R108	19B800607P122	Metal film: 1.2K ohms ±5%, 200 VDCW, 1/8 w.	R240	19B801251P15
109	19B800607P394	Metal film: 390K ohms ±5%, 200 VDCW, 1/8 w.	R241	19B800607P15
110	19B800607P153	Metal film: 15K ohms ±5%, 200 VDCW, 1/8 w.	and R242	ĺ
111	19B800779P10	Variable: 10K ohms ±25%, 100 VDCW, .3 w.	R243	19A702931P13
112	19B800607P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.	R244	19A702931P21
13	19B800607P102	Metal film: 1K ohms ±5%, 200 VDCW, 1/8 w.	R245	19B800607P27
4	19B800607P154	Metal film: 150K ohms ±5%, 200 VDCW, 1/8 w.	and R246	1
15	19B800607P562	Metal film: 5.6K ohms ±5%, 200 VDCW, 1/8 w.	R247	19B800607P27
6	19B800607P183	Metal film: 18K ohms ±5%, 200 VDCW, 1/8 w.	R248	19B800607P47
17	19B800607P562	Metal film: 5.6K ohms ±5%, 200 VDCW, 1/8 w.	R249	19B800607P1
18	19A701864P4	Thermal: 10K ohms ±10%, sim to Midwest Components 2H-103.	R403	19B800607P56
120	19B800607P100	Metal film: 10 ohms ±5%, 200 VDCW, 1/8 w.	R404	19B800607P82
122	19B800607P473	Metal film: 47K ohms ±5%, 200 VDCW, 1/8 w.	R405	19B800607P15
126	19B800607P821	Metal film: 820 ohms ±5%, 200 VDCW, 1/8 w.	R501	19B800607P18
129	19A701864P4	Thermal: 10K ohms ±10%, sim to Midwest Components	R502	19B800607P27
	150,0100414	2H-103.	R503 *	19B800607P82
130	19B800607P183	Metal film: 18K ohms ±5%, 200 VDCW, 1/8 w.	R504	19B800607P27
131	19B800607P680	Metal film: 68 ohms ±5%, 200 VDCW, 1/8 w.	R505	19B800607P68
132	19B800607P221	Metal film: 220 ohms ±5%, 200 VDCW, 1/8 w.	R506	19B800607P82
R133	3R151P100J	Composition: 10 ohms ±5%, 1/8 w.	R507	198800607918
R201	19B800607P330	Metal film: 33 ohms ±5%, 200 VDCW, 1/8 w.	R508	19B800607P10
R202	19B800607P331	Metal film: 330 ohms ±5%, 200 VDCW, 1/8 w.	R509	19B800607P27
203	19B800607P472	Metal film: 4.7K ohms ±5%, 200 VDCW, 1/8 w.	R510	19B800607P27
R204	19B800607P102	Metal film: 1K ohms <u>+</u> 5%, 200 VDCW, 1/8 w.	R511	19B800607P47
R205	198800607P151	Metal film: 150 ohms ±5%, 200 VDCW, 1/8 w.	R512	19B800607P82
R206	19B800607P390	Metal film: 39 ohms ±5%, 200 VDCW, 1/8 w.	R513	19B800779P4
R207	19B800607P151	Metal film: 150 ohms ±5%, 200 VDCW, 1/8 w.	R514 *	19B800607P10
R208	19B800607P331	Metal film: 330 ohms <u>+</u> 5%, 200 VDCW, 1/8 w.	R515	19B800607F10
R209	19B800607P472	Metal film: 4.7K ohms ±5%, 200 VDCW, 1/8 w.	K212	198600607F62
R210	19B800607P102	Metal film: 1K ohms <u>+</u> 5%, 200 VDCW, 1/8 w.		
R211	19B800607P100	Metal film: 10 ohms ±5%, 200 VDCW, 1/8 w.	U102	19A134717P3
R212	19B800607P560	Metal film: 56 ohms ±5%, 200 VDCW, 1/8 w.	U103	19A701789P2
R213	19B800607P221	Metal film: 220 ohms ±5%, 200 VDCW, 1/8 w.	U201	19A704902P1
R214	19B800607P331	Metal film: 330 ohms ±5%, 200 VDCW, 1/8 w.		l
215	19B800607P822	Metal film: 8.2K ohms ±5%, 200 VDCW, 1/8 w.	U202	19A700029P44
			U203	19A704971P1
216	19B800607P222	Metal film: 2.2K ohms ±5%, 200 VDCW, 1/8 w.		1

RT NO.	DESCRIPTION
07P102	Metal film: 1K ohms <u>+</u> 5%, 200 VDCW, 1/8 w.
07P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
07P274	Metal film: 270K ohms ±5%, 200 VDCW, 1/8 w.
07P104	Metal film: 100K ohms <u>+</u> 5%, 200 VDCW, 1/8 w.
07P333	Metal film: 33K ohms ±5%, 200 VDCW, 1/8 w.
07P564	Metal film: 560K ohms ±5%, 200 VDCW, 1/8 w.
07P472	Metal film: 4.7K ohms ±5%, 200 VDCW, 1/8 w.
07P272	Metal film: 2.7K ohms ±5%, 200 VDCW, 1/8 w.
79P4	Variable: 4.7 to 470 ohms ±25%, 100 VDCW, .3 w.
51P473	Metal film: 47K ohm ±5%, 150 VDCW.
07P223	Metal film: 22K ohms ±5%, 200 VDCW, 1/8 w.
07P823	Metal film: 82K ohms ±5%, 200 VDCW, 1/8 w.
07P332	Metal film: 3.3K ohms ±5%, 200 VDCW, 1/8 w.
07P472	Metal film: 4.7K ohms ±5%, 200 VDCW, 1/8 w.
07P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
07P332	Metal film: 3.3K ohms ±5%, 200 VDCW, 1/8 w.
07P472	Metal film: 4.7K ohms ±5%, 200 VDCW, 1/8 w.
07P683	Metal film: 68K ohms ±5%, 200 VDCW, 1/8 w.
07P471	Metal film: 470 ohms ±5%, 200 VDCW, 1/8 w.
07P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
51P154	Metal film: 150K ohm ±5%, 150 VDCW.
07P154	Metal film: 150K ohms ±5%, 200 VDCW, 1/8 w.
31P137	Metal film: 237 ohms ±1%, 200 VDCW, 1/8 w.
31P213	Metal film: 1330 ohms ±1%, 200 VDCW, 1/8 w.
07P272	Metal film: 2.7K ohms ±5%, 200 VDCW, 1/8 w.
07P271	Metal film: 270 ohms ±5%, 200 VDCW, 1/8 w.
07P472	Metal film: 4.7K ohms ±5%, 200 VDCW, 1/8 w.
07P1	Metal Film: 0 ohms (50 Milli-ohms Max), 1/8 w.
07P562	Metal film: 5.6K ohms ±5%, 200 VDCW, 1/8 w.
07P821	Metal film: 820 ohms ±5%, 200 VDCW, 1/8 w.
07P151	Metal film: 150 ohms ±5%, 200 VDCW, 1/8 w.
07P181	Metal film: 180 ohms ±5%, 200 VDCW, 1/8 w.
07P270	Metal film: 27 ohms ±5%, 200 VDCW, 1/8 w.
07P822	Metal film: 8.2K ohms ±5%, 200 VDCW, 1/8 w.
07P270	Metal film: 27 ohms ±5%, 200 VDCW, 1/8 w.
07P683	Metal film: 68K ohms ±5%, 200 VDCW, 1/8 w.
07P823	Metal film: 82K ohms ±5%, 200 VDCW, 1/8 w.
07P183	Metal film: 18K ohms ±5%, 200 VDCW, 1/8 w.
07P101	Metal film: 100 ohms ±5%, 200 VDCW, 1/8 w.
07P272	Metal film: 2.7K ohms ±5%, 200 VDCW, 1/8 w.
07P270	Metal film: 27 ohms ±5%, 200 VDCW, 1/8 w.
07P473	Metal film: 47K ohms ±5%, 200 VDCW, 1/8 w.
07P822	Metal film: 8.2K ohms ±5%, 200 VDCW, 1/8 w.
79P4	Variable: 4.7 to 470 ohms ±25%, 100 VDCW .3 w.
07P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
07P821	Metal film: 820 ohms ±5%, 200 VDCW, 1/8 w.
17P3	Linear: 8 volt regulator; sim to uA7808U.
89P2	Linear: Dual Op Amp; sim to LM358.
02P1	Linear: Dual Band VCO, 806-825 MHz, 851-870 MHz; sim to ALPS URAA.
29P44	Digital: Bilateral Switch.
71P1	Linear: 5 volt regulator; sim to Motorola

Crystal Oscillator: 12.8 Mhz ±3 PPM/'C.

SYMBOL	GE PART NO.	DESCRIPTION
U205	19A704740P1	Digital: Prescaler; sim to Mitsubishi M54475P.
U206	19B800902P4	Digital: PPL Synthesizer, CMOS Serial Input.
U207	19A701999P4	Linear: Voltage regulator; sim to LM317LZ.
U208	19A704971P1	Linear: 5 volt regulator; sim to Motorola MC78L05ACP.
U501	19A704619P1	Linear: IF Amplifier and Detector.
U502	19A704073P2	Linear: 8 volt regulator.
¥501	19A705376P5	Crystal Unit: 45.455 Mhz.
Z401 and Z402	19A704888P1	Bandpass: 851-871 MHz; sim to Murata DFC3R861P020BTD.
Z403	19B801025P2	Balanced Mixer: sim to Mini-Circuits SBL-1X.
Z501	19A705328P1	Monolithic crystal: 45.000 MHz; sim to Toyocom 45E2B2.
Z502		Part of Z501.
Z503	19B801021P2	Bandpass: 455 kHz ±1.5; sim to Murata CFW-455E.
		MISCELLANEOUS
	19B801378G3	Heat Sink Assembly. (With Q101 and U102).
	19B801490P1	Ground Strap.
	19A702364P106	Machine screw: TORX Drive, No. M2 - 0.4 x 6.
	19B801566P1	Shield.
	1	

PRODUCTION CHAN

Changes in the equipment to improve performance or to simplify circuits are identified by a "Hevision Letter which is stamped after the model number of the unit. The revision stamped on the unit includes all previous control of the unit inc

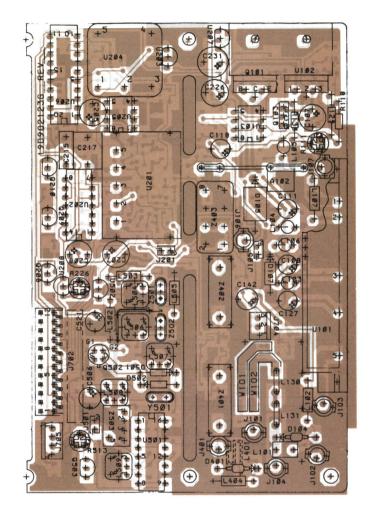
A - TMX8712 RF BOARD 19D902123G1

To improve receiver sensitivity margin, changed C304 C505, R503 and R514. Old parts were: C504: 19A702061P29 Ceramic: 22 pF +5%, 50 VDCW. C505: 19A702061P25 Ceramic: 18 pF +5%, 50 VDCW. R503: 19B800607P682 Metal film: 6.8K ohms +5%.

REV. B - TMX8712 RF BOARD 19D902123G1
To improve upper band receiver sensitivity,
C233 from the collector of 0205 to ground.

9

COMPONENT SIDE



LEAD IDENTIFICATION FOR D201



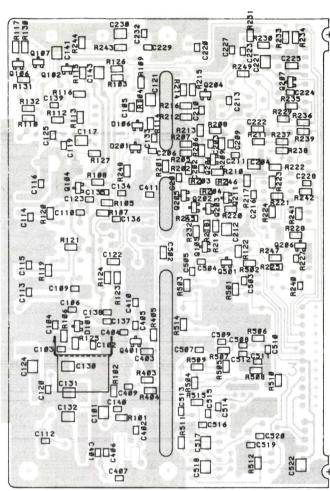
IN-LINE TOP VIEW NOTE: CASE SHAPE IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION FOR Q208, Q209, Q210, & Q503

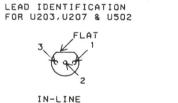


IN-LINE TOP VIEW NOTE: CASE SHAPE IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

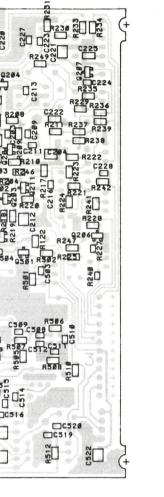
CHIP COMPONENT SIDE

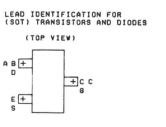


(19D902123, Sh. 1, Rev. 4) (19D902124, Sh. 2, Rev. 3)



IN-LINE TOP VIEW NOTE: CASE SHAPE IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.





R118 R129

₹ R132

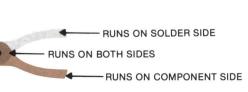
EXCITER INPUT

1. # INDICATES CHIP COMPONENT LOCATED ON SOLDER SIDE OF P.W.B.

2. A PART OF P.W.B.

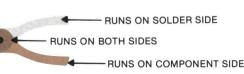
3. ALL RESISTORS ARE 1/4 WATT UNLESS
OTHERWISE SPECIFIED AND RESISTOR
VALUES IN OHMS UNLESS FOLLOWED BY
K-1000 OHMS OR M-1,000,000 OHMS.
CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY U-MICROFARADS.INDUCTANCE VALUES
IN MICROHENRYS UNLESS FOLLOWED BY
MH-MILLIHENRYS, NH-NANOHENRYS OR

MODEL NO. REV. LETTER 19D902123G1



POWER LVL CONTROL INPUT

EX OUT J107



RF BOARD 19D902123G1

(19D902228, Sh. 1, Rev. 3)

0104

BV SHS.283

Tx SWITCH

SWITCHED 8V

\$\begin{align*}
\text{R103} & \text{R126} \\ \text{820} & \text{820} \end{align*}

0102

T.1u

V CONTROL

R107

十 5 3 3 5

I : C114 {L107

POWER CONTROL

SW A+

R108

POWER SET

A102

EXCITER

R117 5.6k

R130 =

T C1119

A PART OF PWB

L105 TC118

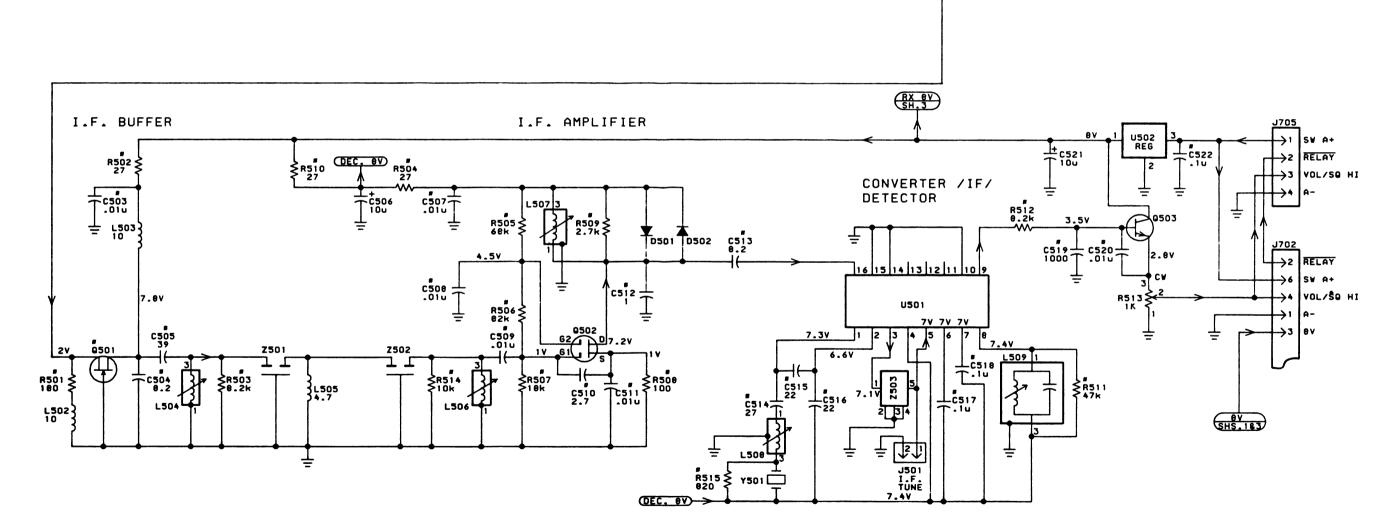
十476

R112 ≥

MIXER

Z402





PRE-AMPLIFIER

0401

[∆]L403

∆ L402

₹ R403 ₹ 5.6k

₹ R404

#R405 150

Ţ 1000

(BS-BV SH3)

Z401

RX INPUT

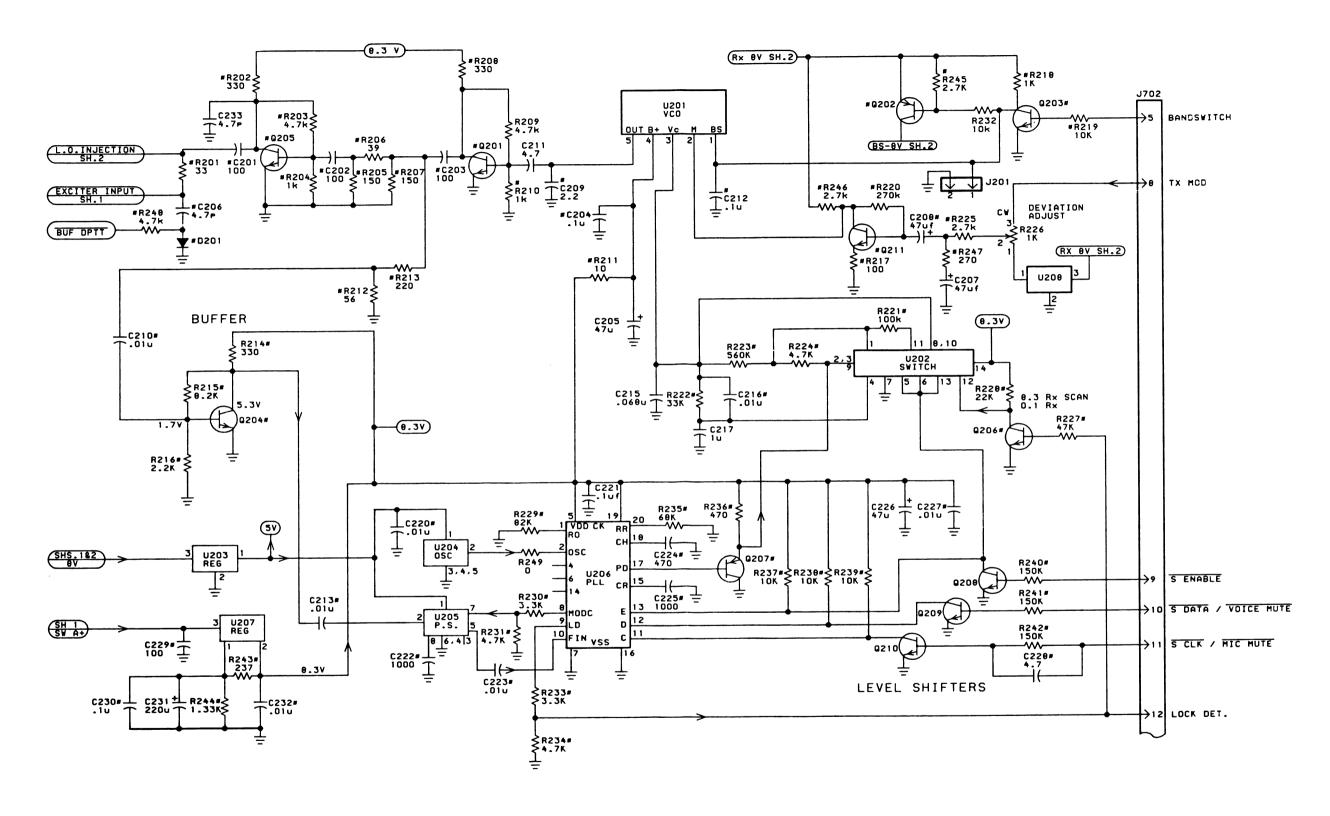
⊚–

{L401

T C407

(19D902228, Sh. 2, Rev. 1)

RF BOARD 19D902123G1



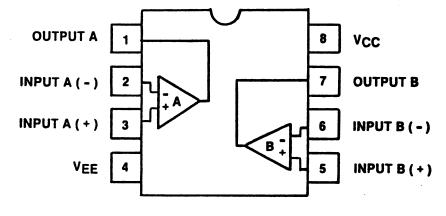
RF BOARD

19D902123G1

12

(19D902228, Sh. 3, Rev. 1)

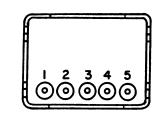
OPERATIONAL AMPLIFIER (U103) 19A701789P2



RC-5750

VOLTAGE CONTROLLED OSCILLATOR

(U201) 19A704902PI



PIN	FUNCTION
ı	SWITCH
2	MOD
3	CONTROL
4	Vcc
5	OUTPUT

RC-8008

CRYSTAL CONTROLLED OSCILLATOR (U204) 198801351P3



PIN CONNECTIONS

I. + Vcc

2. OUTPUT

3. COMMON & CASE

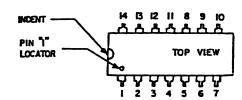
4. COMMON & CASE *

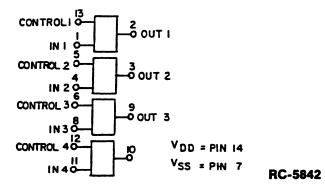
5. COMMON & CASE

* PIN 4 IS PERMISSABLE NOT NECESSARY FOR OPERATION.

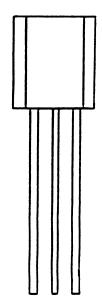
QUAD BILATERAL SWITCH (U202) 19A700029P44

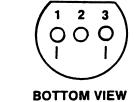
PIN CONFIGURATION





VOLTAGE REGULATOR (U203) 19A704971P1



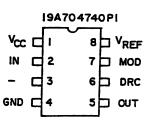


PIN INDENTIFICATION

PIN 1 ADJUST PIN 2. OUTPUT PIN 3. INPUT

RC-5854A

PRESCALER



I VCC POWER SUPPLY (+5V) 5 OUT SIGNAL

2 IN SIGNAL INPUT

3- NO CONNECTION

4 GND GROUND

7 MOD MODULUS CONTROL INPUT

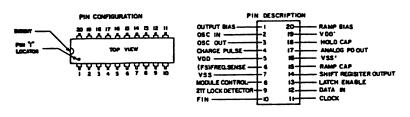
6 DRC DIVISION RATIO CONTROL (V_{CC}: 64/65, OPEN 128/129)

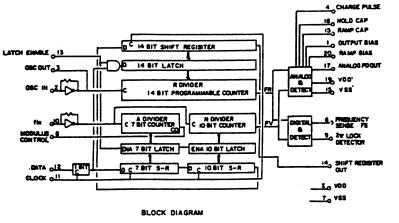
8 VREFREFERENCE BIAS INPUT

RC-8043

LBI-38195 IC DATA

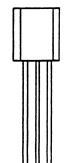
PHASE-LOCK-LOOP MODULE (U206) 19B800902P4





RC-5843

VOLTAGE REGULATOR (U207) 19A701999P4

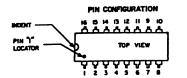


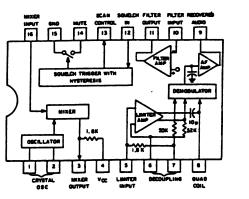


PIN 1 ADJUST PIN 2. OUTPUT PIN 3. INPUT

RC-5846

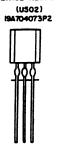
IF AMPLIFIER AND DETECTOR (USOI) 19A704619PI





BLOCK DIAGRAM





BOTTOM VIEW

PIN I - OUTPUT PIN 2 - GROUND

RC-5289